# Small Signal MOSFET 

-20 V, -200 mA, Dual P-Channel, $1.0 \times 1.0 \mathrm{~mm}$ SOT-963 Package

## Features

- Dual P-Channel MOSFET
- Offers a Low $\mathrm{R}_{\mathrm{DS}(\text { on })}$ Solution in the Ultra Small $1.0 \times 1.0 \mathrm{~mm}$ Package
- 1.5 V Gate Voltage Rating
- Ultra Thin Profile ( $<0.5 \mathrm{~mm}$ ) Allows It to Fit Easily into Extremely Thin Environments such as Portable Electronics.
- This is a $\mathrm{Pb}-$ Free Device


## Applications

- High Side Switch
- High Speed Interfacing
- Optimized for Power Management in Ultra Portable Equipment

MAXIMUM RATINGS $\left(\mathrm{T}_{J}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified)

| Parameter |  |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Drain-to-Source Voltage |  |  | $\mathrm{V}_{\text {DSS }}$ | -20 | V |
| Gate-to-Source Voltage |  |  | $\mathrm{V}_{\mathrm{GS}}$ | $\pm 8$ | V |
| Continuous Drain Current (Note 1) | Steady State | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $I_{\text {D }}$ | -200 | mA |
|  |  | $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$ |  | -140 |  |
|  | $\mathrm{t} \leq 5 \mathrm{~s}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | -250 |  |
| Power Dissipation (Note 1) | Steady State | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | -125 | mW |
|  | $\mathrm{t} \leq 5 \mathrm{~s}$ |  |  | -200 |  |
| Pulsed Drain Current |  | $\mathrm{t}_{\mathrm{p}}=10 \mu \mathrm{~s}$ | IDM | -600 | mA |
| Operating Junction and Storage Temperature |  |  | $\mathrm{T}_{\mathrm{J},}$ | $\begin{gathered} -55 \text { to } \\ 150 \end{gathered}$ | ${ }^{\circ} \mathrm{C}$ |
| Source Current (Body Diode) (Note 2) |  |  | Is | -200 | mA |
| Lead Temperature for Soldering Purposes ( $1 / 8^{\prime \prime}$ from case for 10 s ) |  |  | $\mathrm{T}_{\mathrm{L}}$ | 260 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using the minimum recommended pad size, 1 ozCu .
2. Pulse Test: pulse width $\leq 300 \mu \mathrm{~s}$, duty cycle $\leq 2 \%$


## ON Semiconductor ${ }^{\circledR}$

http://onsemi.com


PINOUT: SOT-963


Top View


4 = Specific Device Code
M = Date Code
$=$ Pb-Free Package

## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

## NTUD3171PZ

THERMAL RESISTANCE RATINGS

| Parameter | Symbol | Max | Unit |
| :--- | :---: | :---: | :---: |
| Junction-to-Ambient - Steady State (Note 3) | $\mathrm{R}_{\theta J \mathrm{~A}}$ | 1000 |  |
|  |  | 600 |  |

3. Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz Cu .

ELECTRICAL CHARACTERISTICS $\left(\mathrm{T}_{J}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified)

| Parameter | Symbol | Test Condition |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS |  |  |  |  |  |  |  |
| Drain-to-Source Breakdown Voltage | $\mathrm{V}_{\text {(BR) } \mathrm{DSS}}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ |  | -20 |  |  | V |
| Zero Gate Voltage Drain Current | IDSS | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=-5.0 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  | -50 | nA |
|  |  | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=-5.0 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{J}}=85^{\circ} \mathrm{C}$ |  |  | -100 |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=-16 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  | -200 |  |
| Gate-to-Source Leakage Current | IGSS | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}= \pm 5.0 \mathrm{~V}$ |  |  |  | $\pm 100$ | nA |

ON CHARACTERISTICS (Note 4)

| Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}}(\mathrm{TH})$ | $\mathrm{V}_{\mathrm{GS}}=\mathrm{V}_{\mathrm{DS}}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ | -0.4 |  | -1.0 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Drain-to-Source On Resistance | $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ | $\mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-100 \mathrm{~mA}$ |  | 2.0 | 5.0 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{GS}}=-2.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-50 \mathrm{~mA}$ |  | 2.6 | 6.0 |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=-1.8 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-20 \mathrm{~mA}$ |  | 3.4 | 7.0 |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=-1.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-10 \mathrm{~mA}$ |  | 4.0 | 10 |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=-1.2 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-1.0 \mathrm{~mA}$ |  | 6.0 |  |  |
| Forward Transconductance | gFs | $\mathrm{V}_{\mathrm{DS}}=-5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-125 \mathrm{~mA}$ |  | 0.35 |  | S |
| Source-Drain Diode Voltage | $\mathrm{V}_{\mathrm{SD}}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA}$ |  | -0.6 | -1.0 | V |

CHARGES, CAPACITANCES AND GATE RESISTANCE

| Input Capacitance | $\mathrm{C}_{\text {ISS }}$ | $\begin{gathered} f=1 \mathrm{MHz}, V_{G S}=0 \mathrm{~V} \\ V_{D S}=-15 \mathrm{~V} \end{gathered}$ | 13.5 | pF |
| :---: | :---: | :---: | :---: | :---: |
| Output Capacitance | Coss |  | 3.8 |  |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {RSS }}$ |  | 2.0 |  |

SWITCHING CHARACTERISTICS, $\mathbf{V}_{\mathbf{G S}}=4.5 \mathrm{~V}$ (Note 4)

| Turn-On Delay Time | $\mathrm{t}_{\mathrm{d}(\mathrm{ON})}$ | $\begin{gathered} \mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=-15 \mathrm{~V}, \\ \mathrm{I}_{\mathrm{D}}=-200 \mathrm{~mA}, \mathrm{R}_{\mathrm{G}}=2.0 \Omega \end{gathered}$ | 26 | ns |
| :---: | :---: | :---: | :---: | :---: |
| Rise Time | $\mathrm{tr}_{\mathrm{r}}$ |  | 46 |  |
| Turn-Off Delay Time | $\mathrm{t}_{\mathrm{d} \text { (OFF) }}$ |  | 196 |  |
| Fall Time | $\mathrm{t}_{\mathrm{f}}$ |  | 145 |  |

4. Switching characteristics are independent of operating junction temperatures

ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :---: | :--- | :---: |
| NTUD3171PZT5G | SOT-963 <br> (Pb-Free) | $8000 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## NTUD3171PZ

## TYPICAL CHARACTERISTICS



VDS, DRAIN-TO-SOURCE VOLTAGE (V)
Figure 1. On-Region Characteristics

$\mathrm{V}_{\mathrm{GS}}$, GATE-TO-SOURCE VOLTAGE (V)
Figure 3. On-Resistance vs. Gate Voltage


Figure 5. On-Resistance Variation with Temperature

$\mathrm{V}_{\mathrm{GS}}$, GATE-TO-SOURCE VOLTAGE (V)
Figure 2. Transfer Characteristics


Figure 4. On-Resistance vs. Drain Current and Gate Voltage


Figure 6. Drain-to-Source Leakage Current vs. Voltage

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TYPICAL CHARACTERISTICS


Figure 7. Capacitance Variation


Figure 8. Resistive Switching Time Variation vs. Gate Resistance


Figure 9. Diode Forward Voltage vs. Current

SOT-963
CASE 527AD-01 ISSUE E
SCALE 4:1


TOP VIEW


SIDE VIEW

$$
\text { BOTTOM VIEW } \begin{array}{|l|l|l|l|}
\hline & 0.08 & \mathrm{X} & \mathrm{Y} \\
\hline
\end{array}
$$

STYLE 1:
PIN 1. EMITTER 1 2. BASE 1
3. COLLECTOR 2
4. EMITTER 2
5. BASE 2
6. COLLECTOR 1

STYLE 4:
PIN 1. COLLECTOR
2. COLLECTOR
3. BASE
4. EMITTER
5. COLLECTOR
6. COLLECTOR

STYLE 7 :
PIN 1. CAThode
2. ANODE
3. CATHODE
4. CATHODE
5. ANODE
6. CATHODE

STYLE 10:
PIN 1. CATHODE 1
2. $\mathrm{N} / \mathrm{C}$
3. CATHODE 2
4. ANODE 2
5. $\mathrm{N} / \mathrm{C}$
6. ANODE 1

STYLE 2:
PIN 1. EMITTER 1
2. EMITTER2
3. BASE 2
4. COLLECTOR 2
5. BASE 1
6. COLLECTOR 1

STYLE 5:
PIN 1. CATHODE
2. CATHODE
3. ANODE
4. ANODE
5. CATHODE

STYLE 8:
PIN 1. DRAIN
2. DRAIN
3. GATE
4. SOURCE
5. DRAIN
6. DRAIN

STYLE 3:
PIN 1. CATHODE 1
2. CATHODE 1
3. ANODE/ANODE 2
4. CATHODE 2
6. ANODE/ANODE 1

STYLE 6:
PIN 1. CATHODE
2. ANODE
2. ANTHEDE
3. CATHODE
4. CATHODE
6. CATHODE

STYLE 9:
PIN 1. SOURCE 1
2. GATE 1
3. DRAIN 2
4. SOURCE 2
5. GATE 2
6. DRAIN 1

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | SOT-963, 1X1, 0.35P | PAGE 1 OF 1 |

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